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Product Change Notification - JAON-27DRIR445

0	2						
Date:	06 Jun 2016						
roduct Category:	Analog (Thermal, Power Mana	Analog (Thermal, Power Management & Safety)					
otification subject:	CCB 2638.001 Final Notice: Qualification of non-conductive die attach epoxy 8900NC for se						
Notification text:	products available in 8L SOIC package at MTAI assembly site. PCN Status: Final notification						
	Microchip Parts Affected: Please open the attachments foun	d in the attachments field	below labeled as PCN_#	_Affected_CPN.			
	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).						
	Description of Change: Qualification of non-conductive die attach epoxy 8900NC for selected products available in 8L SOIC package MTAI assembly site.						
	Pre Change: Using conductive die attach epoxy 8390A.						
	Post Change: Using non-conductive die attach e Pre and Post Change Summary:						
		Pre Change	Post Change				
	Assembly Site	MTAI assembly site	MTAI assembly site				
	Wire material	Au or PdCu wire	Au or PdCu wire				
	Die attach material	8390A	8900NC				
	Die attach conductive	Yes	No				
	Molding compound material	6600	G600				
	Molding compound material	G600	Good				
	Lead frame material	CDA194	CDA194				

Impacts to Data Sheet:

None

Reason for Change: To improve productivity by qualifying non-conductive die attach epoxy 8900NC at MTAI assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date: As identified for each CPN listed in the attached parts list. NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Summary Table:

	June 2016			>			September 2016							
WW	22	23	24	25	26					35	36	37	38	39
Qual Report Availability		х												
Final PCN Issue Date		х												
Estimated Implementation Date					As li	sted	in tl	he a	ttacl	ned	parts	s list		

Markings to Distinguish Revised from Unrevised Devices: Traceability code

Revision History: June 6, 2016: Issued final notification. Attached the qualification report.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-27DRIR445_Qual_Report.pdf PCN_JAON-27DRIR445_Affected_CPN.pdf PCN_JAON-27DRIR445_Affected_CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

PCN_JAON-27DRIR445					
CATALOG_PART_NBR	Estimated First Ship Date (EFSD)				
MCP1403-E/SN	June 17, 2016				
MCP1403T-E/SN	June 17, 2016				
MCP1404-E/SN	June 17, 2016				
MCP1404-E/SNVAO	September 30, 2016				
MCP1404T-E/SN	June 17, 2016				
MCP1404T-E/SNVAO	September 30, 2016				
MCP1405-E/SN	June 17, 2016				
MCP1405T-E/SN	June 17, 2016				
MCP1405T-E/SNVAO	September 30, 2016				
MCP14A0153-E/SN	June 17, 2016				
MCP14A0153T-E/SN	June 17, 2016				
MCP14A0154-E/SN	June 17, 2016				
MCP14A0154T-E/SN	June 17, 2016				
MCP14A0155-E/SN	June 17, 2016				
MCP14A0155T-E/SN	June 17, 2016				
MCP14E3-E/SN	June 17, 2016				
MCP14E3T-E/SN	June 17, 2016				
MCP14E4-E/SN	June 17, 2016				
MCP14E4T-E/SN	June 17, 2016				
MCP14E4T-E/SNVAO	September 30, 2016				
MCP14E5-E/SN	June 17, 2016				
MCP14E5T-E/SN	June 17, 2016				
TC1426COA	June 17, 2016				
TC1426COA713	June 17, 2016				
TC1427COA	June 17, 2016				
TC1427COA713	June 17, 2016				
TC1428COA	June 17, 2016				
TC1428COA713	June 17, 2016				
TC426COA	June 17, 2016				
TC426COA713	June 17, 2016				
TC426EOA	June 17, 2016				
TC426EOA713	June 17, 2016				
TC427COA	June 17, 2016				
TC427COA713	June 17, 2016				
TC427EOA	June 17, 2016				
TC427EOA713	June 17, 2016				
TC427VOA	June 17, 2016				
TC427VOA713	June 17, 2016				
TC428COA	June 17, 2016				
TC428COA713	June 17, 2016				
TC428EOA	June 17, 2016				
TC428EOA713	June 17, 2016				
TC428VOA	June 17, 2016				

JAON-27DRIR445 - CCB 2638.001 Final Notice: Qualification of non-conductive die attach epoxy 8900NC for selected products available in 8L SOIC package at MTAI assembly site.

Affected Catalog Part Numbers (CPN)

PCN_JAON-27DRIR445					
CATALOG_PART_NBR	Estimated First Ship Date (EFSD)				
TC428VOA713	June 17, 2016				
TC4423AVOA	June 17, 2016				
TC4423AVOA713	June 17, 2016				
TC4424AVOA	June 17, 2016				
TC4424AVOA713	June 17, 2016				
TC4424AVOA713APP	June 17, 2016				
TC4425AVOA	June 17, 2016				
TC4425AVOA713	June 17, 2016				
TC4426ACOA	June 17, 2016				
TC4426ACOA713	June 17, 2016				
TC4426AEOA	June 17, 2016				
TC4426AEOA713	June 17, 2016				
TC4426AVOA	June 17, 2016				
TC4426AVOA713	June 17, 2016				
TC4426COA	June 17, 2016				
TC4426COA713	June 17, 2016				
TC4426COA713CAA	June 17, 2016				
TC4426EOA	June 17, 2016				
TC4426EOA713	June 17, 2016				
TC4426VOA	June 17, 2016				
TC4426VOA713	June 17, 2016				
TC4427ACOA	June 17, 2016				
TC4427ACOA713	June 17, 2016				
TC4427AEOA	June 17, 2016				
TC4427AEOA713	June 17, 2016				
TC4427AEOA713AAA	June 17, 2016				
TC4427AEOAAAA	June 17, 2016				
TC4427AVOA	June 17, 2016				
TC4427AVOA713	June 17, 2016				
TC4427AVOA713-VAO	September 30, 2016				
TC4427AVOA-VAO	September 30, 2016				
TC4427COA	June 17, 2016				
TC4427COA713	June 17, 2016				
TC4427COA713HAZ	June 17, 2016				
TC4427COA723	June 17, 2016				
TC4427EOA	June 17, 2016				
TC4427EOA713	June 17, 2016				
TC4427EOA-VAO	September 30, 2016				
TC4427VOA	June 17, 2016				
TC4427VOA713	June 17, 2016				
TC4428ACOA	June 17, 2016				
TC4428ACOA713	June 17, 2016				
TC4428ACOA713-GTD	June 17, 2016				

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Affected Catalog Part Numbers (CPN)

PCN_JAON-27DRIR445					
CATALOG_PART_NBR	Estimated First Ship Date (EFSD)				
TC4428AEOA	June 17, 2016				
TC4428AEOA713	June 17, 2016				
TC4428AVOA	June 17, 2016				
TC4428AVOA713	June 17, 2016				
TC4428AVOA713-VAO	September 30, 2016				
TC4428COA	June 17, 2016				
TC4428COA713	June 17, 2016				
TC4428COA723	June 17, 2016				
TC4428DCOA	June 17, 2016				
TC4428EOA	June 17, 2016				
TC4428EOA713	June 17, 2016				
TC4428VOA	June 17, 2016				
TC4428VOA713	June 17, 2016				
TC4428VOA713-VAO	September 30, 2016				